

Wide Supply TIA-485/TIA-422 Transceiver with 1.65V-5.5V I/O Interface

Description

The XR33202 is a high performance TIA-485/TIA-422 transceiver designed to meet the increasing system requirements found in today's portable/handheld, process control and industrial equipment environments. This is a wide supply (3.0V to 5.5V) device that operates at maximum data rate of 20Mbps and features a 1.65V to 5.5V I/O logic supply, simplifying multi-voltage system interfacing requirements.

The receiver includes full fail-safe circuitry, guaranteeing a logic-high receiver output when the receiver inputs are open, shorted or undriven. The XR33202 receiver input impedance is at least $96k\Omega$ (1/8 unit load), allowing more than 256 devices on the bus.

The driver is protected by short circuit detection as well as thermal shutdown and maintains high impedance in shutdown or when powered off. The XR33202 does not have slew limiting and is intended for high speed applications requiring data rates up to 20Mbps.

The DE and \overline{RE} pins include hot swap circuitry to prevent false transitions on the bus during power up or live insertion and can enter a 1µA low current shutdown mode for extreme power savings.

The XR33202 is a half-duplex device that operates at max data rates of 20Mbps. It is available in a 10-pin DFN package.

FEATURES

- Wide 3.0V to 5.5V supply operation
- 1.65V to 5.5V I/O logic interface VL pin
- Enhanced receiver fail-safe protection for open, shorted or terminated but idle data lines
- Hot swap glitch protection on DE and RE Pins
- Robust ESD (Electrostatic Discharge) protection for TIA-485 bus pins
 - □ ±15kV human body model
 - □ ±15kV IEC61000-4-2 air discharge
- □ ±8kV IEC61000-4-2 contact discharge
- Driver short circuit limit and thermal shutdown for overload protection
- -40°C to 125°C ambient operating temperature range
- Lead-free (RoHS 6) DFN

APPLICATIONS

- Portable and handheld equipment
- Industrial and process control equipment
- Point-of-sale equipment
- Building security and automation

Typical Application

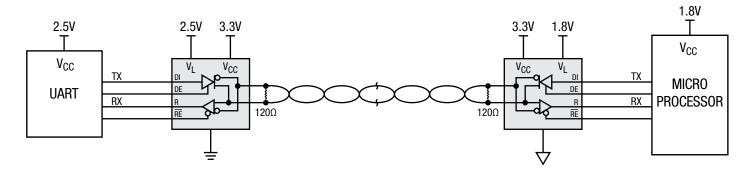


Figure 1. Typical Application

REV1A 1/7

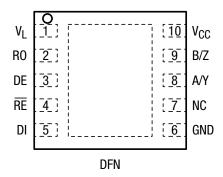
Absolute Maximum Ratings

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Maximum Rating condition for extended periods may affect device reliability and lifetime.

Supply voltage (V _{CC})		-0.3V to 7.0V		
Logic interface voltage (V _L)		V _L ≤ V _{CC}		
Junction temperature		150ºC		
Input voltages	DE and DI	-0.3V to 6.0V		
	RE	-0.3V to (V _L + 0.3V)		
Output voltage	RO	-0.3V to (V _L + 0.3V)		
Driver output voltage A/Y, B/Z		±18V		
Receiver input voltages	A/Y, B/Z	±18V		
Operating Conditions				
Operating temperature range		-40°C to 125°C		
V _{CC} supply range		3.0V to 5.5V		
V _L I/O supply range (VL ≤ V _{CC})		1.65V to 5.5V		
Thermal Information				
θ_{JA}		40.5°C/W		
θυς		8.5°C/W		



Pin Configuration



Pin Functions

Pin Number	Pin Name	Туре	Description	
1	V _L	Supply	I/O power supply, sets the logic levels for RO, DE, RE and DI	
2	RO	Output	Receiver output	
3	DE	Input	Driver enable, driver active when DE = 1, disabled when DE = 0	
4	RE	Input	Receiver enable, receiver is disabled when $\overline{RE} = 1$, enabled when $\overline{RE} = 0$	
5	DI	Input	Driver input	
6	GND	Supply	Ground	
7	NC		No connection, can be connected to ground	
8	A/Y	I/O	±15kV ESD protected, TIA-485/TIA-422 half-duplex non-inverting receiver input and non-inverting driver output	
9	B/Z	I/O	±15kV ESD protected, TIA-485/TIA-422 half-duplex inverting receiver input and inverting driver output	
10	V _{CC}	Supply	Power supply	
*	Paddle		Exposed paddle (DFN package), connect to ground	



Electrical Characteristics

Specifications are at T_A = 25°C, V_{CC} = 3.3V±10% or 5.0V±10%, V_L = V_{CC} unless otherwise noted. Typical values represent the most likely parametric norm at T_A = 25°C, and are provided for reference purposes only.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
Driver DC Cl	haracteristics					
		RL = 100Ω (TIA-422), $V_{CC} = 3.0V$	2.0			V
V	Differential driver output	RL = 54Ω (TIA-485), $V_{CC} = 3.0V$	1.5			V
V _{OD}	Differential driver output	RL = 100Ω (TIA-422), $V_{CC} = 4.5V$	2.25			V
		RL = 54Ω (TIA-485), $V_{CC} = 4.5V$	2.25			V
ΔV_{OD}	Change in magnitude of differential output voltage	RL = 100Ω or 54Ω	-0.2		0.2	V
V _{CM}	Driver common-mode output voltage (steady state)	RL = 100Ω or 54Ω		V _{CC/2}	3	V
ΔV_{CM}	Change in magnitude of common-mode output voltage	RL = 100Ω or 54Ω	-0.2		0.2	V
ا ا	Input current (A and B)	$V_{OUT} = 12V$, DE = 0V $V_{CC} = 0V$ or 5.5V			125	μΑ
I _{A, B}	input current (A and B)	$V_{OUT} = -7V$, DE = 0V $V_{CC} = 0V$ or 5.5V	-100			μΑ
loL	Output leakage (Y and Z)	$V_{OUT} = 12V, DE = 0V$ $V_{CC} = 0V \text{ or } 5.5V$			125	μΑ
		V _{OUT} = -7V, DE = 0V V _{CC} = 0V or 5.5V	-100			μA
I _{OSD}	Driver short-circuit output current	-7V ≤ V _{OUT} ≤ +12V	-250		250	mA
Receiver DC	Characteristics					
V_{TH}	Receiver differential threshold voltage (V _A - V _B)	-7V ≤ V _{CM} ≤ 12V	-200	-125	-50	mV
ΔV_{OH}	Receiver input hysteresis	V _{CM} = 0V		25		mV
R _{IN}	Receiver input resistance	-7V ≤ V _{CM} ≤ 12V	96			kΩ
losc	Receiver output short-circuit current	$0V \le V_{RO} \le V_{L}$	-120		120	mA
Logic Inputs	and Outputs					
V_{IH}	Logic input thresholds (DI, DE, RE)	Logic input high	2/3*V _L			V
V_{IL}	$1.65V \le V_{L} \le 5.5V \& V_{L} \le V_{CC}$	Logic input low			1/3*V _L	V
V_{HYS}	Input hysteresis (DI, DE, RE)			50		mV
I _{IN}	Logic input current (DI, DE, RE)	$0V \le V_{IN} \le V_{L}$, after first transition			1	μΑ
I _{INHS}	Logic input current hot swap (DE and RE)	Until first transition			±320	μΑ
V _{OH}	Receiver output high voltage (RO)	$3.0V \le V_L \le 5.5V$, $I_{OUT} = -1mA$ $1.6V \le V_L \le 3.0V$, $I_{OUT} = -1mA$	V _L - 0.6			V
V _{OL}	Receiver output low voltage (RO)	$3.0V \le V_L \le 5.5V$, $I_{OUT} = 1mA$ $1.6V \le V_L \le 3.0V$, $I_{OUT} = 1mA$			0.4	V
I _{OZR}	High-Z receiver output current	$0V \le V_{OUT} \le V_{L}$	-1		1	μA



Electrical Characteristics

Specifications are at T_A = 25°C, V_{CC} = 3.3V±10% or 5.0V±10%, V_L = V_{CC} unless otherwise noted. Typical values represent the most likely parametric norm at T_A = 25°C, and are provided for reference purposes only.

Symbol	Parameter	Conditions	Min	Тур	Max	Units		
Supply	Supply							
V _{CC}	Supply voltage range		3.0		5.5	V		
Icc	Supply current	No load. $\overline{RE} = 0V$, DE = V _L , DI = 0V		400	600	μΑ		
		No load. $\overline{RE} = V_L$, DE = V_L , DI = 0V		300	600	μΑ		
		No load. RE = 0V, DE = 0V, receiver A and B inputs open		300	500	μΑ		
I _{SHDN}	Supply current in shutdwon mode	$\overline{RE} = V_L$, DE = 0V		0.05	3	μΑ		
ESD Protection	ESD Protection							
		Human body model (HBM)		±15		kV		
	ESD protection for TIA-485 bus pins (A/Y, B/Z)	IEC 61000-4-2 airgap		±15		kV		
	, , ,	IEC 61000-4-2 contact		±8		kV		
	ESD protection for all other pins	Human body model (HBM)		±4		kV		

Driver AC Characteristics - XR33202

Specifications are at T_A = 25°C, V_{CC} = 3.3V±10% or 5.0V±10%, V_L = V_{CC} unless otherwise noted. Typical values represent the most likely parametric norm at T_A = 25°C, and are provided for reference purposes only.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
t _{DPLH}	Driver prop. delay (low to high)				30	ns
t _{DPHL}	Driver prop. delay (high to low)	O 50-5 D 540			30	ns
It _{DPLH} -t _{DPHL} I	Differential driver output skew	$C_L = 50 pF, R_L = 54 \Omega,$			5	ns
t _{DR} , t _{DF}	Driver differential output rise or fall time				17	ns
	Maximum data rate	1/t _{UI} , duty cycle 40% to 60%	20			Mbps
t _{DZH}	Driver enable to output high				50	ns
t _{DZL}	Driver enable to output low	O 50=5 D 5000			50	ns
t _{DHZ}	Driver disable from output high	$C_L = 50pF, R_L = 500\Omega,$			50	ns
t _{DLZ}	Driver disable from output low				50	ns
t _{DZH(SHDN)}	Driver enable from shutdown to output high	C 50x5 B 5000			250	ns
t _{DZL(SHDN)}	Driver enable from shutdown to output low	$C_L = 50 pF, R_L = 500 \Omega,$			250	ns
t _{SHDN}	Time to shutdown		50	200	600	ns



Receiver AC Characteristics - XR33202

Specifications are at T_A = 25°C, V_{CC} = 3.3V±10% or 5.0V±10%, V_L = V_{CC} unless otherwise noted. Typical values represent the most likely parametric norm at T_A = 25°C, and are provided for reference purposes only.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
t _{RPLH}	Receiver prop. delay (low to high)				50	ns
t _{RPHL}	Receiver prop. delay (high to low)	$C_L = 50 pF, R_L = 54 \Omega$			50	ns
It _{RPLH} -t _{RPHL} I	Receiver propagation delay skew				5	ns
	Maximum data rate	1/t _{UI} , duty cycle 40% to 60%	20			Mbps
t _{RZH}	Receiver enable to output high				50	ns
t _{RZL}	Receiver enable to output low	0 50-5 D 410			50	ns
t _{RHZ}	Receiver disable from output high	$C_L = 50 pF, R_L = 1 k\Omega,$			50	ns
t _{RLZ}	Receiver disable from output low				50	ns
[†] RZH(SHDN)	Receiver enable from shutdown to output high	0 50-5 D 410			2200	ns
^t RZL(SHDN)	Receiver enable from shutdown to output low	$C_L = 50pF, R_L = 1k\Omega,$			2200	ns
t _{SHDN}	Time to shutdown		50	200	600	ns

Block Diagram

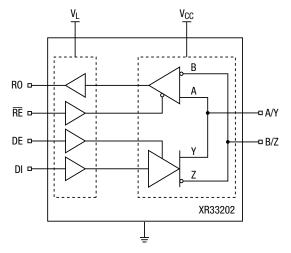
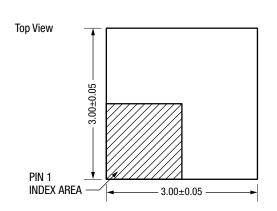


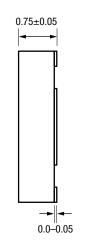
Figure 2. Block Diagram



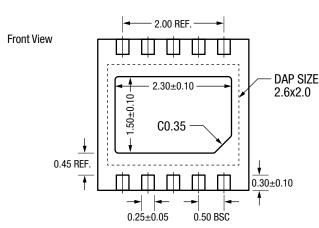
Package Description

10-Pin DFN Package (3mm x 3mm)



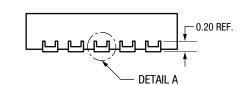


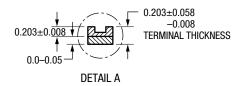
Side View



NOTES:

- 1. All dimensions are in millimeters (angle in degrees), unless otherwise specified.
- Coplanarity applies to the exposed pad as well as the terminals. Coplanarity shall not exceed 0.05mm.
- 3. Warpage shall not exceed 0.05mm.
- 4. Package length/package width are considered as special characteristics.
- 5. Refer JEDEC MO-229.
- L/F stock #FR0O45 (Ag on lead only). UTL PKG code TD-300E300B010A or TD-300S300B010A or TD-300M300B010A or TD-300D300B010A.





Order Information

Part Number	Package	Environmental Rating	Operating Temperature Range
XR33202EEHB-F	10-pin DFN	Green	-40°C to 125°C
XR33202EEHBTR-F	10-pin DFN	Green	-40°C to 125°C



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